

SE20DB, SE20DD, SE20DG, SE20DJ

Vishay General Semiconductor

Surface-Mount ESD Capability Rectifiers



SE20DX

Anode 1 O K Anode 2 O Cathode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	20 A				
V _{RRM}	100 V, 200 V, 400 V, 600 V				
I _{FSM}	150 A				
V_F at I_F = 20 A (T_A = 125 °C)	1.03 V				
I _R	25 µA				
T _J max.	175 °C				
Package	SMPD (TO-263AC)				
Circuit configurations	Single				

FEATURES

- Very low profile typical height of 1.7 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- AEC-Q101 qualified
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL SE20DB SE20DD SE20DG SE20DJ				SE20DJ	UNIT
Maximum repetitive peak reverse voltage	V _{RRM} 100 200 400 600		V			
Maximum DC forward current	I _F ⁽¹⁾	20				A
	I _F ⁽²⁾	3.9				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	150			А	
Operating junction and storage temperature range	T _J , T _{STG} -55 to +175			°C		

Notes

⁽¹⁾ With heatsink

⁽²⁾ Free air, mounted on recommended copper pad area

Document Number: 87794





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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 10 A	– T _A = 25 °C	V _F ⁽¹⁾	0.98	-	V
	I _F = 20 A			1.10	1.20	
	I _F = 10 A	- T _A = 125 °C		0.88	-	
	I _F = 20 A			1.03	1.15	
Reverse current	Rotod V	T _A = 25 °C	1 (2)	-	25	μA
	Rated V _R	T _A = 125 °C	- I _R ⁽²⁾	38	150	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	3000	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	150	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25$ °c unless otherwise noted)						
PARAMETER SYMBOL SE20DB SE20DD SE20DG SE20DJ UNIT						
Typical thermal resistance	R _{0JA} (1)(2)		°C/W			
	R _{0JC} ⁽³⁾	1.6				C/W

Notes

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

⁽³⁾ With infinite heatsink

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T _A = 25 °C unless otherwise noted)						
STANDARD	STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS VALUE					
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 k Ω	V _C	H3B	> 8 kV	

ORDERING INFORMATION (Example)						
STANDARD	PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SMPD (TO-263AC)	SE20DJ-M3/I	0.54	I	2000/reel	13" diameter plastic tape and reel	
SMPD (TO-263AC)	SE20DJHM3/I ⁽¹⁾	0.54	I	2000/reel	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

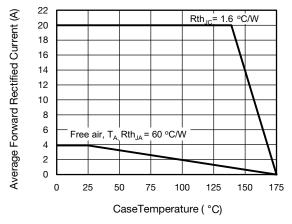


Fig. 1 - Forward Current Derating Curve

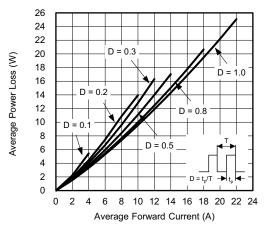


Fig. 2 - Forward Power Loss Characteristics

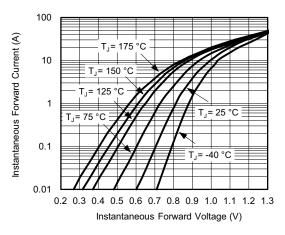


Fig. 3 - Typical Instantaneous Forward Characteristics

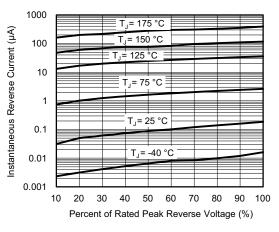


Fig. 4 - Typical Reverse Leakage Characteristics

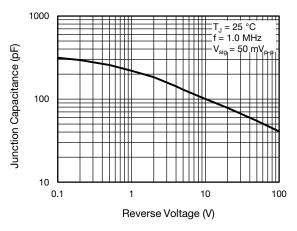


Fig. 5 - Typical Junction Capacitance

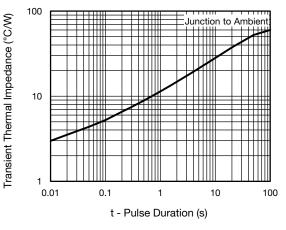


Fig. 6 - Typical Transient Thermal Impedance

Revision: 20-Jan-2022

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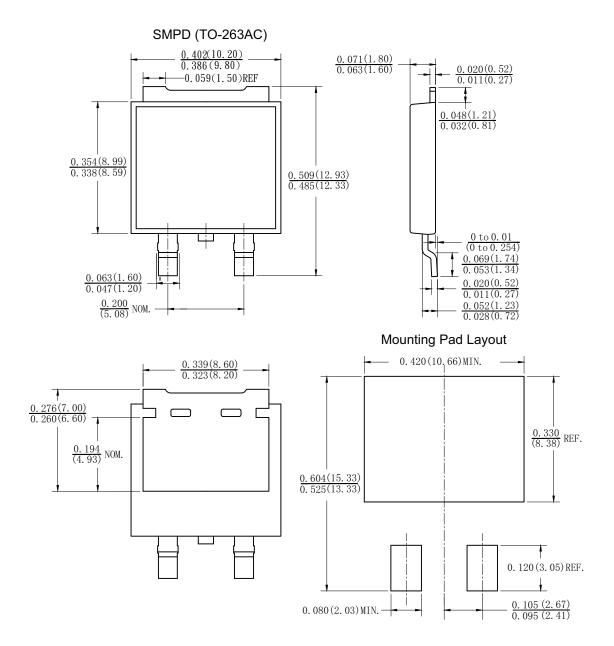
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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